

**BM601M** 

Order Code:

Version: A0

Gas Discharge Tube

Features

- Size Design 8.3×8.3×6mm
- High Current Handling Capability 20,000A @ 8/20μs
- Low Capacitance and Insertion Loss
- Fast Response and Long Service Life
- Reliable to Protect Electrostatic Surge
- Moisture sensitivity level: Level 1

Exterior

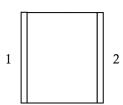


**SMD** 

#### Application information

AC Power

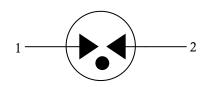
Package (Top View)



#### Agency Approvals

Icon	Description		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
8	Mean lead free		
<b>.R</b> .	Compliance with UL1449, Certificated E337906		

Schematic Symbol



#### **Electrical Parameter**

DC Breakdown Voltage <sup>1) 2)</sup>	100V/s	480-720	V
Impulse Sperk over Voltage	At 1kV/μs	for 99 % of measured values ≤ 950	V
Impulse Spark-over Voltage	At 1kV/μs	Typical values of distribution ≤ 900	V
Impulse Discharge Current <sup>3)</sup>	Impulse Discharge Current <sup>3</sup> 8/20μs ±5times 20,000		A
Arc Voltage	At 1A	~15	V
Insulation Resistance	DC=100V	≥1	GΩ
Capacitance at 1 MHz	VDC=0.5V	≤1.5	pF
Weight		~1.75	g
Operating and storage Temperature		-40-90	$^{\circ}$ C
Marking		Without	

- 1) At delivery AQL 0.65 level II GB/T 2828.1-2003 2) In ionized mode
- 3) Terms and current waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21



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Version: A0 2013-09-14

### Part Numbering System

# BM 601 M (1) (2) (3)

- (1) Bencent SMD Gas Discharge Tube with  $8.3\times8.3\times6$  (L×W×H) (mm) dimension
- (2) DC Breakdown Voltage, e.g., 091=9×10<sup>1</sup>=90V
- (3) Tolerance is DC Breakdown Voltage, M=±20%, N=±30%

#### **Product Characteristics**

Lead Material	Copper
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

#### **Environmental Reliability Characteristics**

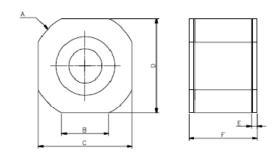
Testing items	Technical standards
High Temperature Storage Test	Temperature: 85 °C Time:2H
Low Temperature Storage Test	Temperature: -40°C Time:2H
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45mins
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 1time

Note: Up-screen program can be specified by customer's request via contacting Bencent service

## Solderability test

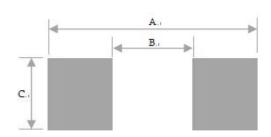
Solderability	Solder Pot Temperature:	245°C ±5°C
	Solder Dwell Time:	4-6 seconds

#### **Product Dimensions**



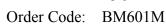
REF	mm	inch		
A	Ф9.3±0.1	Ф0.366±0.004		
В	4.2±0.1	0.165±0.004		
С	8.3±0.2	0.327±0.008		
D	8.3±0.2	0.327±0.008		
Е	0.5±0.05	0.02±0.002		
F	6±0.2	0.236±0.008		

#### recommended soldering pad



REF	mm	inch
A	7.95	0.313
В	4.5	0.177
С	8	0.315

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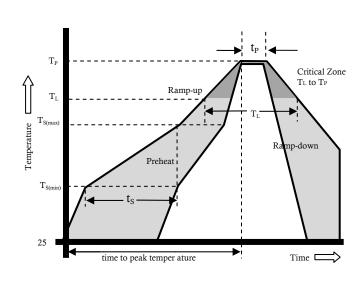




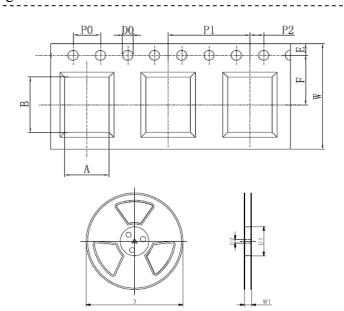
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# reflow profile

Reflow Condition			Pb-Free assembly	
Pre	Temperature Min		150°C	
Heat	Te	emperature Max	200°C	
пеаі	Ti	ime (min to max)	60 – 180 secs	
Average ramp up rate (Liquids) Tamp $(T_L)$ to peal			3°C/second max	
T <sub>s</sub> (max)	to	T <sub>L</sub> - Ramp-up Rate	3°C/second max	
Reflow		- Temperature (T <sub>L</sub> ) (Liquids)	217°C	
		- Temperature (T <sub>L</sub> )	60 – 150 seconds	
Peak Ter	Peak Temperature (T <sub>p</sub> )		260+0/-5 °C	
Time within 5°C of actual peak Temperature $(t_p)$		-	20 – 40 seconds	
Ramp-de	Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T <sub>p</sub> )		to peak Temperature	8 minutes Max.	
Do not exceed		eed	260°C	



## Package Reel Information



REF	mm	inch
P0	4.0±0.1	0.157±0.004
D0	$\Phi 1.5^{+0.1}_{-0}$	$\Phi 0.059^{+0.004}_{-0}$
P1	12±0.1	0.472±0.004
P2	2.0±0.1	0.079±0.004
A	$6.5 \pm 0.2$	$0.256 \pm 0.008$
В	$8.4 \pm 0.2$	$0.331 \pm 0.008$
F	7.5±0.1	0.295±0.004
Е	1.75±0.1	0.069±0.004
W	16±0.3	0.63±0.012
D	Ф330±2	Φ12.99±0.079
D1	Φ100±2	$\Phi$ 3.94 $\pm$ 0.079
D2	Φ13±0.15	0.512±0.006
W1	21±2	0.827±0.079

	OUTLINE REEL (PCS)	INSIDE	PER CARTON (PCS)	CARTON SIZE(mm)		
OUTLINE		CARTON (PCS)		L	W	Н
TAPING	500	1000	8000	360	360	380